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## Patent Abstracts of Japan

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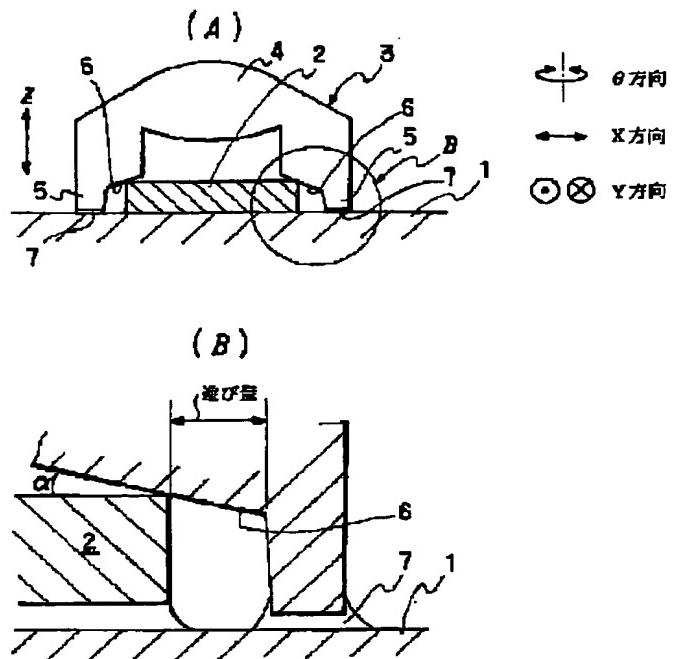
APPLICATION DATE : 25-10-95  
APPLICATION NUMBER : 07302169

APPLICANT : SONY CORP;

INVENTOR : IKEDA SHIGEO;

INT.CL. : H01L 27/14 H04N 5/335

TITLE : SEMICONDUCTOR OPTICAL DEVICE



ABSTRACT : PROBLEM TO BE SOLVED: To mount a lens fixing member on a solid state image sensor while positioning easily without causing any damage thereon.

SOLUTION: A lens fixing member 3 is provided with an inclining face 6 for positioning the lens fixing member 3 itself such that a specified positional relationship is kept between a solid state imaging sensor 2 and a lens 4 touching the upper edge on the side face thereof when the lens fixing member 3 is secured to a substrate 1 through the legs 5. Under a state where the inclining face 6 touches the upper edge on the side face of solid state imaging sensor 2, the lens fixing member 3 is positioned with respect to the solid state imaging sensor 2 and bonded onto the substrate 1.

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